Preferred Devices

Surface Mount Ultrafast Power Rectifiers

MURS105T3, MURS110T3, MURS115T3, MURS120T3, MURS140T3, MURS160T3

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 V Max @ 1.0 A, $T_J = 150$ °C)
- Pb-Free Packages are Available

Mechanical Characteristics:

- · Case: Epoxy, Molded
- Weight: 95 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIERS 1.0 AMPERE, 50-600 VOLTS



SMB CASE 403A

MARKING DIAGRAM



A = Assembly Location

/ = Year

WW = Work Week

11 = Device Code

x = A, B, C, D, G, or J = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the table on page 2 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS

		MURS						
Rating	Symbol	105T3	110T3	115T3	120T3	140T3	160T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	150	200	400	600	V
Average Rectified Forward Current	I _{F(AV)}			= 155°C = 145°C	MIN	1.0 @ T _L 2.0 @ T _L	= 150°C = 125°C	Α
Non-Repetitive Peak Surge Current, (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	40 CONT		W 3	55	Α		
Operating Junction Temperature	Ty		MM	-65 to	0 +175	IM		°C

Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS									
1001. ON 114 M. 1003.			MURS						
Rating		Symbol	105T3	110T3	115T3	120T3	140T3	160T3	Ur
Thermal Resistance, Junction-to-Lead	$(T_1 = 25^{\circ}C)$	$R_{\theta JL}$	WIT		1	3 00 7	Time	A.	°C/

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$)	V _F C C	0.875 0.71	1.25 1.05	V
Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_J = 25^{\circ}C$) (Rated DC Voltage, $T_J = 150^{\circ}C$)	i _R	2.0 50	5.0 150	μΑ
Maximum Reverse Recovery Time $ \begin{aligned} (i_F = 1.0 \text{ A, di/dt} = 50 \text{ A/}\mu\text{s}) \\ (i_F = 0.5 \text{ A, } i_R = 1.0 \text{ A, I}_R \text{ to } 0.25 \text{ A}) \end{aligned} $	t _{rr}	35 25	75 50	ns
Maximum Forward Recovery Time (i _F = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t _{fr}	25	50	ns

^{1.} Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2.0%.

DEVICE MARKING AND ORDERING INFORMATION

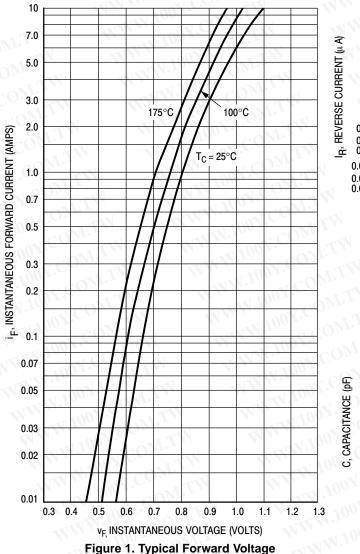
Device	Marking	Package	Shipping [†]				
MURS105T3	OM.	SMB	MAN MAN CON CONT				
MURS105T3G	COM (U1A)	SMB (Pb-Free)	TW WWW.100X.CON				
MURS110T3	COM	SMB	TW WWW.100Y.CO				
MURS110T3G	Y.CO.U1B	SMB (Pb-Free)	W.TW WWW.100X.CO				
MURS115T3	TW.CO.TW	SMB	OM TW WWW. 100Y.				
MURS115T3G	U1C	SMB (Pb-Free)	COM TW WWW.100Y				
MURS120T3	100Y. OM.T	SMB	2500 Units / Tape & Reel				
MURS120T3G	V.100 U1D COM.T	SMB (Pb–Free)	## ## ## ## 000 9 5759170				
MURS140T3	W.1007. COM	SMB	勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736				
MURS140T3G	U1G	SMB (Pb-Free)	胜特力电子(深圳) 86-755-8329878				
MURS160T3	LINN TOO Y CO	SMB	Http://www.100y.com.tw				
MURS160T3G	U1J	SMB (Pb-Free)	TOWN COMP.				

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MURS120T3 Series

MURS105T3, MURS110T3, MURS115T3, MURS120T3



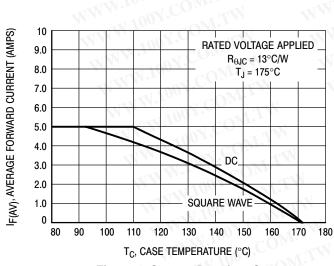


Figure 4. Current Derating, Case

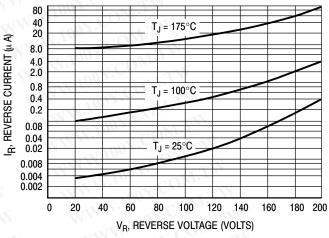


Figure 2. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied V_R is sufficiently below rated V_R.

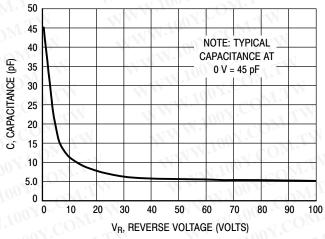


Figure 3. Typical Capacitance

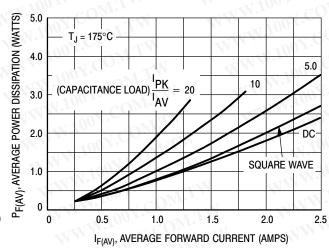
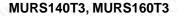


Figure 5. Power Dissipation

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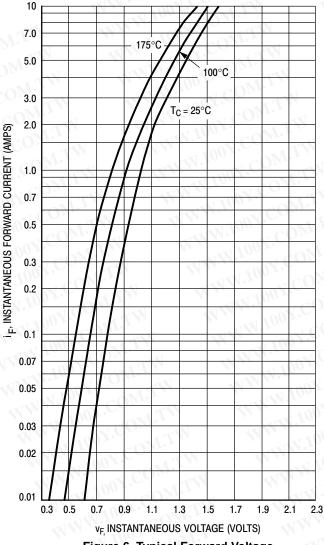


Figure 6. Typical Forward Voltage

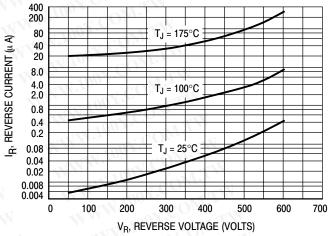


Figure 7. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied V_R is sufficiently below rated V_R.

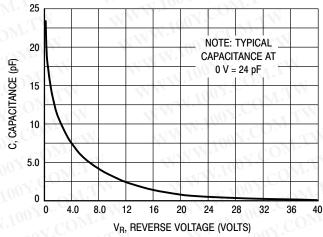


Figure 8. Typical Capacitance

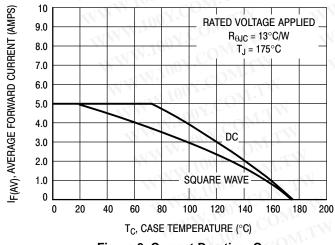


Figure 9. Current Derating, Case

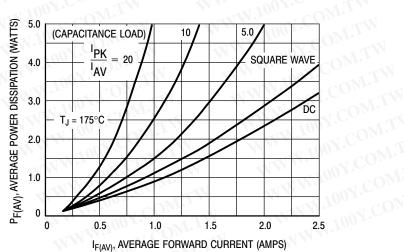
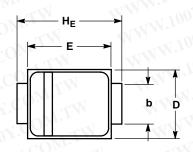
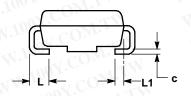


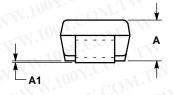
Figure 10. Power Dissipation

PACKAGE DIMENSIONS

SMB CASE 403A-03 ISSUE F







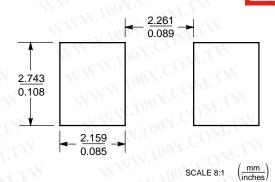
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	MILLIMETERS			INCHES				
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	1.90	2.13	2.45	0.075	0.084	0.096		
A1	0.05	0.10	0.20	0.002	0.004	0.008		
b	1.96	2.03	2.20	0.077	0.080	0.087		
С	0.15	0.23	0.31	0.006	0.009	0.012		
D	3.30	3.56	3.95	0.130	0.140	0.156		
E	4.06	4.32	4.60	0.160	0.170	0.181		
HE	5.21	5.44	5.60	0.205	0.214	0.220		
LX	0.76	1.02	1.60	0.030	0.040	0.063		
L1		0.51 REF		W. P.	0.020 REF			

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SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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